

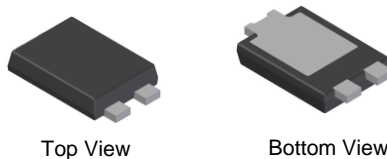
## Features

- Guard Ring Die Construction for Transient Protection
- Low Forward Voltage Drop
- Very Low Leakage Current
- Highly Stable Oxide Passivated Junction
- High Forward Surge Current Capability
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

## Mechanical Data

- Case: PowerDI<sup>®</sup>5
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208(3)
- Polarity: See Diagram
- Weight: 0.096 grams (Approximate)

PowerDI5



LEFT PIN ○ RIGHT PIN ○

BOTTOMSIDE HEAT SINK

**Note:** Pins Left & Right must be electrically connected at the printed circuit board.

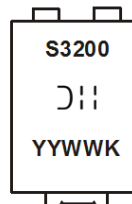
## Ordering Information (Note 5)

Part Number	Qualification	Case	Packaging
PDS3200-13	Commercial	PowerDI5	5,000/Tape & Reel
PDS3200Q-13	Automotive	PowerDI5	5,000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to <https://www.diodes.com/quality/>.
  5. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information

PowerDI5



S3200 = Product Type Marking Code  
 D I = Manufacturer's Code Marking  
 YYWW = Date Code Marking  
 YY = Last Two Digits of Year (ex: 18 for 2018)  
 WW = Week Code (01 to 53)  
 K = Factory Designator

## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
 For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	200	V
Working Peak Reverse Voltage	V <sub>RWM</sub>		
DC Blocking Voltage	V <sub>R</sub>		
RMS Reverse Voltage	V <sub>R(RMS)</sub>	141	V
Average Rectified Output Current	I <sub>O</sub>	3	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	180	A

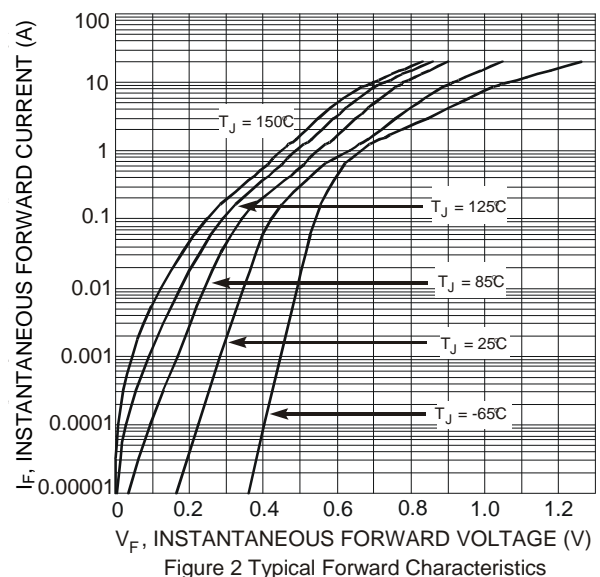
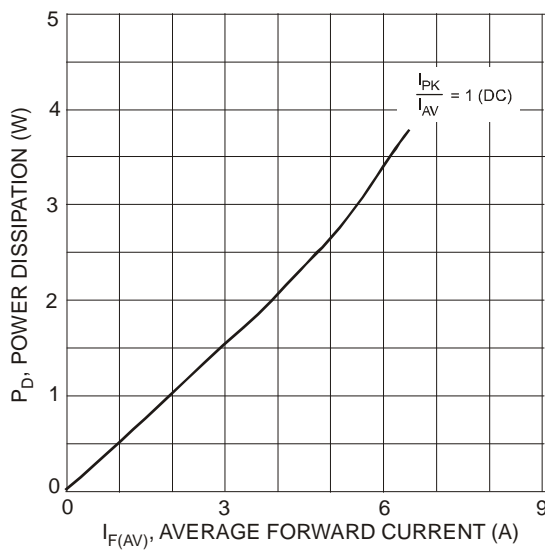
## Thermal Characteristics

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	R <sub>θJS</sub>	—	2.0	°C/W
Thermal Resistance Junction to Ambient Air (Note 6) T <sub>A</sub> = +25°C	R <sub>θJA</sub>	75	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 7) T <sub>A</sub> = +25°C	R <sub>θJA</sub>	60	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 8) T <sub>A</sub> = +25°C	R <sub>θJA</sub>	45	—	°C/W
Operating Temperature Range	T <sub>J</sub>	-65 to +150		°C
Storage Temperature Range	T <sub>STG</sub>	-65 to +175		°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 9)	V <sub>(BR)R</sub>	200	—	—	V	I <sub>R</sub> = 10μA
Forward Voltage	V <sub>F</sub>	—	0.75	0.78	V	I <sub>F</sub> = 3A, T <sub>S</sub> = +25°C
		—	0.59	0.64		I <sub>F</sub> = 3A, T <sub>S</sub> = +125°C
		—	0.82	0.88		I <sub>F</sub> = 6A, T <sub>S</sub> = +25°C
		—	0.66	0.71		I <sub>F</sub> = 6A, T <sub>S</sub> = +125°C
Reverse Leakage Current (Note 9)	I <sub>R</sub>	—	1	10	μA	T <sub>S</sub> = +25°C, V <sub>R</sub> = 200V
		—	0.8	4.5	mA	T <sub>S</sub> = +125°C, V <sub>R</sub> = 200V

- Notes:
6. FR-4 PCB, 2oz. Copper, minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.
  7. Polyimide PCB, 2oz. Copper, minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.
  8. Polyimide PCB, 2oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
  9. Short duration pulse test used to minimize self-heating effect.



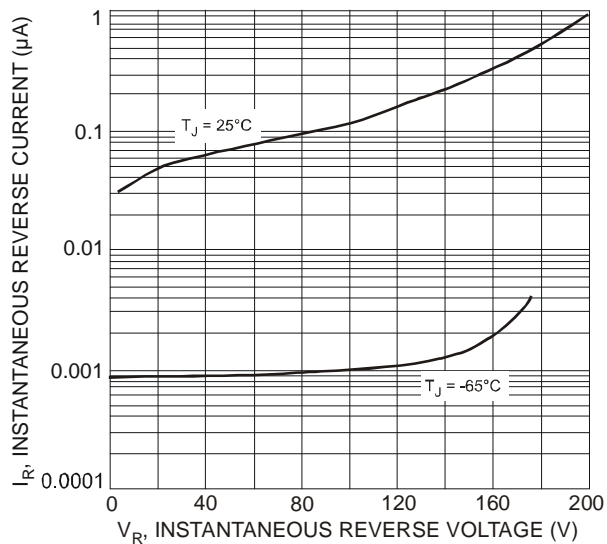


Figure 3 Typical Reverse Characteristics

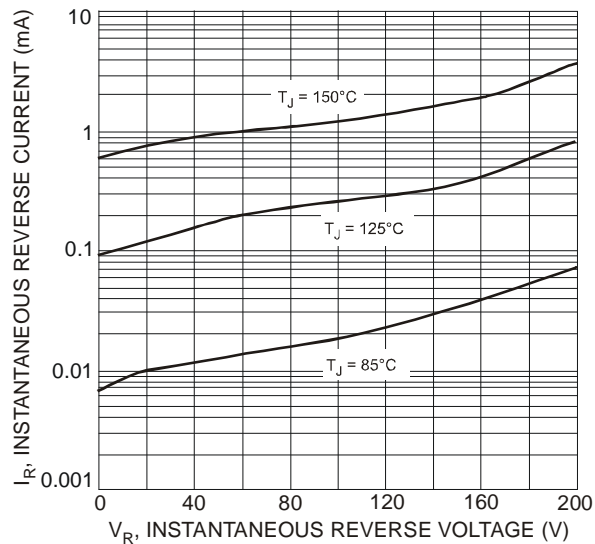


Figure 4 Typical Reverse Characteristics

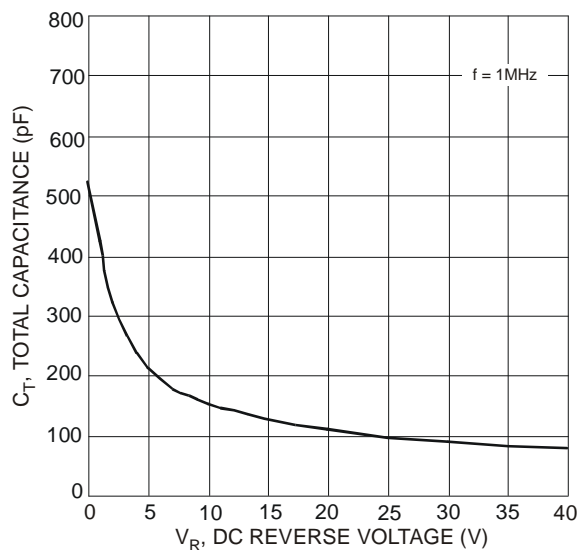


Figure 5 Typical Capacitance vs. Reverse Voltage

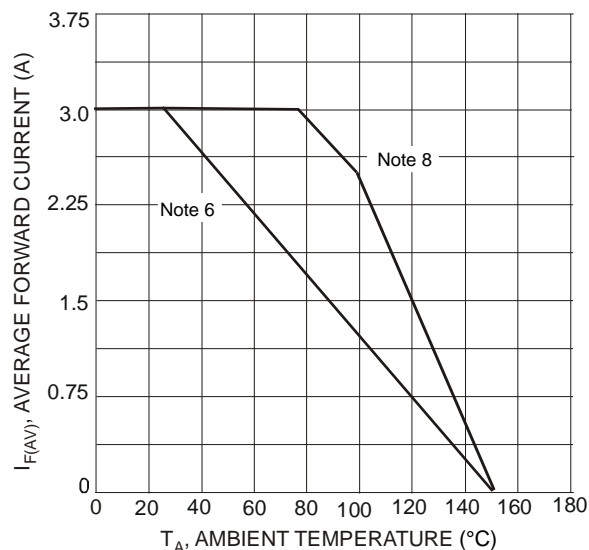


Figure 6 Forward Current Derating Curve

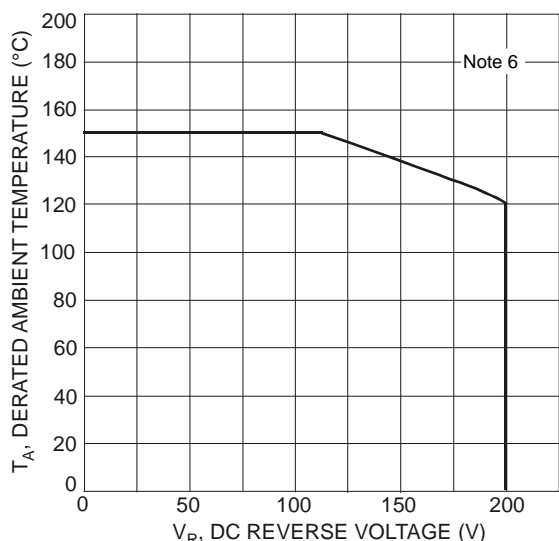
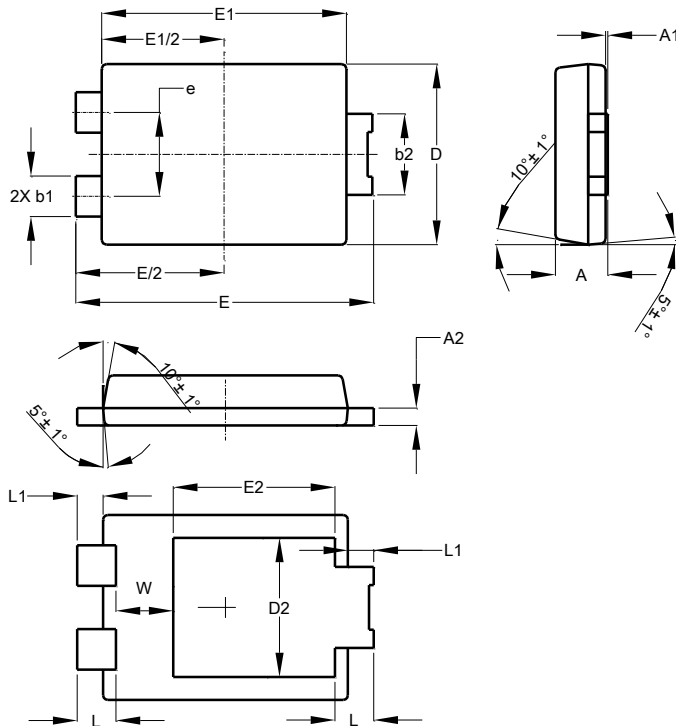


Figure 7 Operating Temperature Derating

## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**PowerDI5**

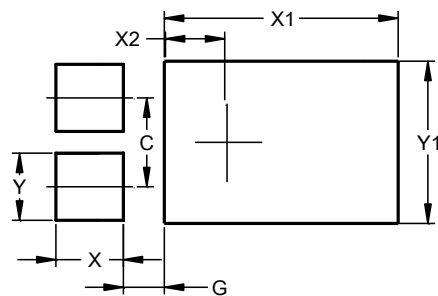


PowerDI5			
Dim	Min	Max	Typ
A	1.05	1.15	1.10
A1	0.00	0.05	--
A2	0.33	0.43	0.381
b1	0.80	0.99	0.89
b2	1.70	1.88	1.78
D	3.90	4.05	3.966
D2	--	--	3.054
E	6.40	6.60	6.51
e	--	--	1.84
E1	5.30	5.45	5.37
E2	--	--	3.549
L	0.75	0.95	0.85
L1	0.50	0.65	0.57
W	1.10	1.41	1.255
All Dimensions in mm			

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**PowerDI5**



Dimensions	Value (in mm)
C	1.840
G	0.852
X	1.400
X1	4.860
X2	1.310
Y	1.390
Y1	3.360

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